

2SK1169, 2SK1170

Silicon N Channel MOS FET

REJ03G0916-0200

(Previous: ADE-208-1254)

Rev.2.00 Sep 07, 2005

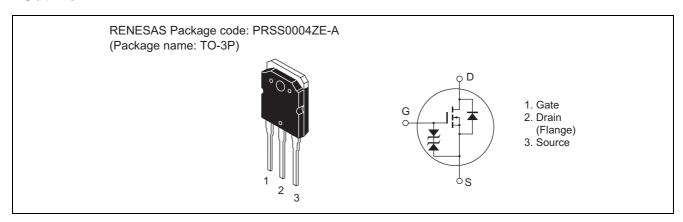
Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator and DC-DC converter

Outline



www.DaAbsolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

| Item | | Symbol | Ratings | Unit |
|---|---------|--------------------------|-------------|------|
| Drain to source voltage 2SK1169 | | V_{DSS} | 450 | V |
| | 2SK1170 | | 500 | |
| Gate to source voltage | | V_{GSS} | ±30 | V |
| Drain current | | I _D | 20 | А |
| Drain peak current | | I _{D(pulse)} *1 | 80 | А |
| Body to drain diode reverse drain current | | I_{DR} | 20 | А |
| Channel dissipation | | Pch*2 | 120 | W |
| Channel temperature | | Tch | 150 | °C |
| Storage temperature | | Tstg | -55 to +150 | °C |

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_C = 25$ °C

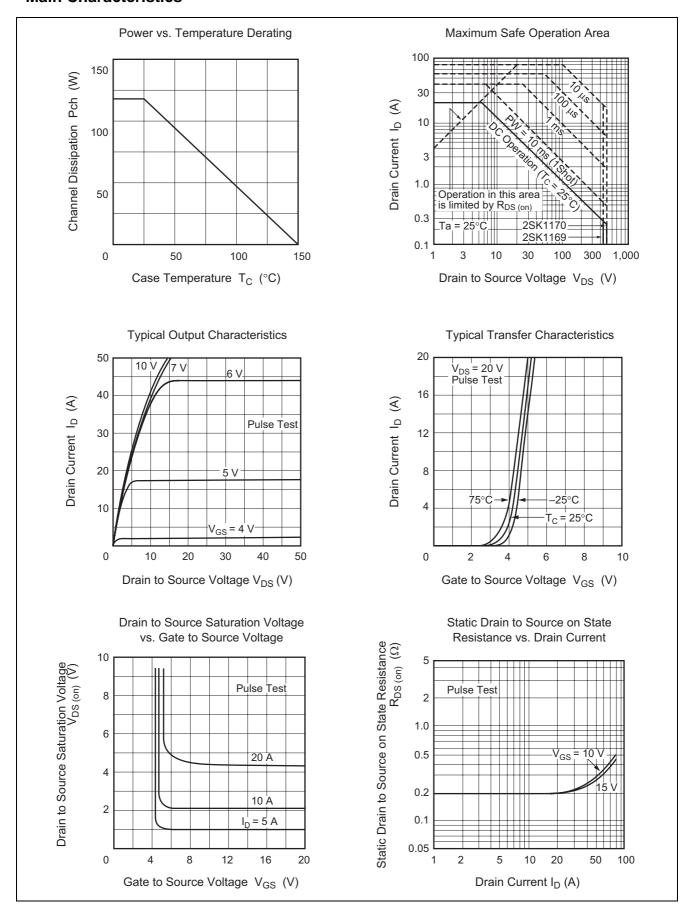
Electrical Characteristics

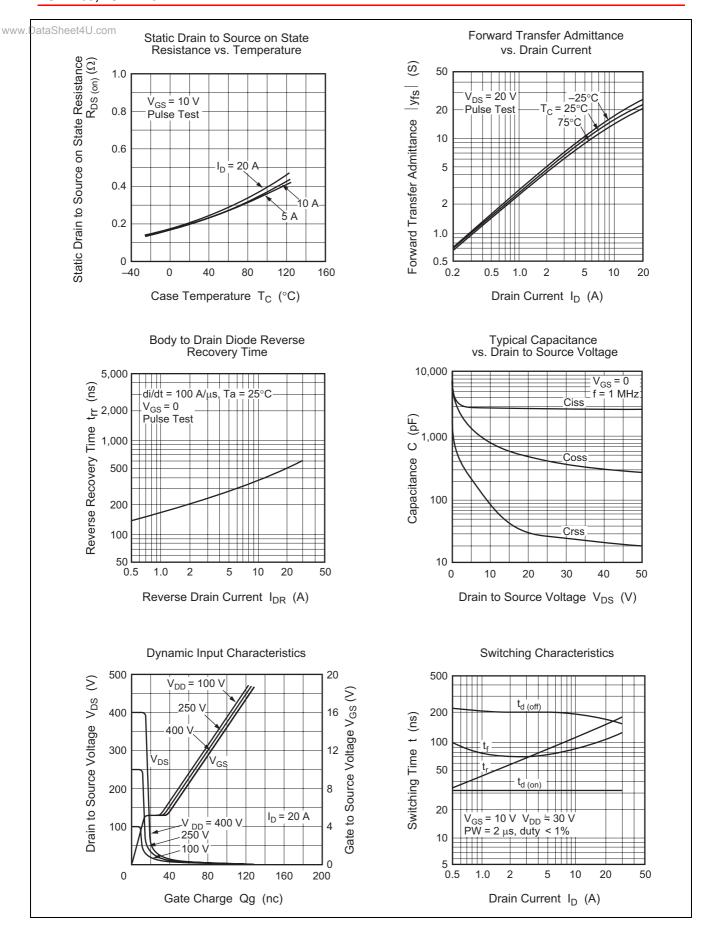
 $(Ta = 25^{\circ}C)$

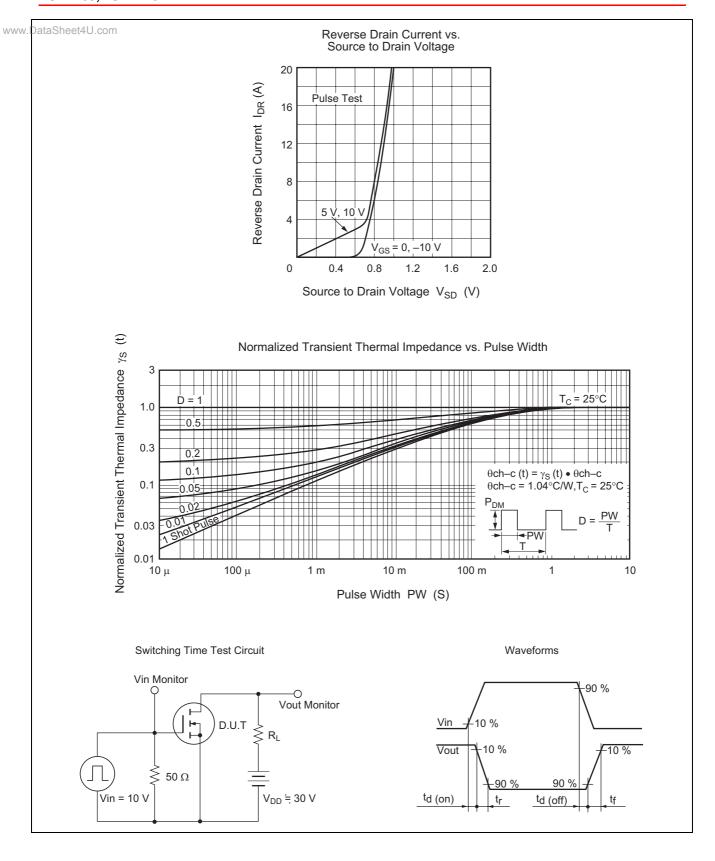
| Item | | Symbol | Min | Тур | Max | Unit | Test conditions |
|--------------------------------------|---------|---------------------|-----|------|------|------|--|
| Drain to source | 2SK1169 | $V_{(BR)DSS}$ | 450 | _ | _ | V | $I_D = 10 \text{ mA}, V_{GS} = 0$ |
| breakdown voltage | 2SK1170 | | 500 | | | | |
| Gate to source breakdown voltage | | $V_{(BR)GSS}$ | ±30 | 1 | 1 | V | $I_G = \pm 100 \ \mu A, \ V_{DS} = 0$ |
| Gate to source leak current | | I_{GSS} | _ | _ | ±10 | μΑ | $V_{GS} = \pm 25 \text{ V}, V_{DS} = 0$ |
| Zero gate voltage drain | 2SK1169 | I _{DSS} | _ | _ | 250 | μΑ | $V_{DS} = 360 \text{ V}, V_{GS} = 0$ |
| current | 2SK1170 | | | | | | $V_{DS} = 400 \text{ V}, V_{GS} = 0$ |
| Gate to source cutoff voltage | | $V_{GS(off)}$ | 2.0 | 1 | 3.0 | V | $I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$ |
| Static drain to source on | 2SK1169 | R _{DS(on)} | _ | 0.20 | 0.25 | Ω | $I_D = 10 \text{ A}, V_{GS} = 10 \text{ V}^{*3}$ |
| state resistance | 2SK1170 | | _ | 0.22 | 0.27 | | |
| Forward transfer admittance | | y _{fs} | 10 | 16 | | S | $I_D = 10 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$ |
| Input capacitance | | Ciss | _ | 2800 | _ | pF | $V_{DS} = 10 \text{ V}, V_{GS} = 0,$ |
| Output capacitance | | Coss | _ | 780 | _ | pF | f = 1 MHz |
| Reverse transfer capacitance | | Crss | _ | 90 | _ | pF | |
| Turn-on delay time | | t _{d(on)} | _ | 32 | _ | ns | $I_D = 10 \text{ A}, V_{GS} = 10 \text{ V},$ |
| Rise time | | t _r | _ | 115 | _ | ns | $R_L = 3 \Omega$ |
| Turn-off delay time | | $t_{d(off)}$ | _ | 200 | _ | ns | |
| Fall time | | t _f | _ | 90 | _ | ns | |
| Body to drain diode forward voltage | | V_{DF} | _ | 1.0 | _ | V | I _F = 20 A, V _{GS} = 0 |
| Body to drain diode reverse recovery | | t _{rr} | _ | 500 | _ | ns | $I_F = 20 \text{ A}, V_{GS} = 0,$ |
| time | | | | | | | $di_F/dt = 100 A/\mu s$ |

Note: 3. Pulse test

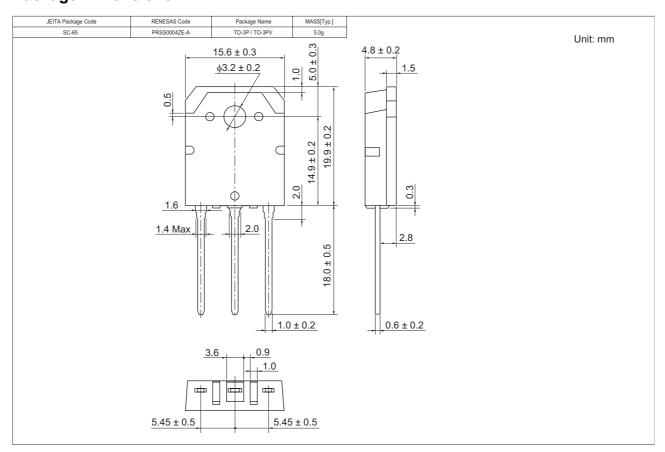
www.DaMaint Characteristics







www.Dapackage Dimensions



Ordering Information

| Part Name | Quantity | Shipping Container | |
|-----------|----------|--------------------|--|
| 2SK1169-E | 360 pcs | Box (Tube) | |
| 2SK1170-E | 360 pcs | Box (Tube) | |

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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